

## SANYO Semiconductors DATA SHEET

N-Channel Silicon MOSFET

# ECH8601R — General-Purpose Switching Device **Applications**

#### **Features**

- · Low ON-resistance.
- · Built-in gate protection resistor.
- 2.5V drive.
- · Best suited for LiB charging and discharging Switch.
- · Common-drain type.

#### **Specifications**

#### Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		20	V
Gate-to-Source Voltage	VGSS		±12	V
Drain Current (DC)	ΙD		6.5	Α
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	40	Α
Allowable Power Dissipation	PD	Mounted on a ceramic board (900mm <sup>2</sup> X0.8mm) 1unit	1.4	W
Total Dissipation	PT	Mounted on a ceramic board (900mm <sup>2</sup> X0.8mm)	1.5	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

#### Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Llmit
			min	typ	max	Unit
Drain-to-Source Breakdown Voltage	V(BR)DSS	ID=1mA, VGS=0V	20			V
Zero-Gate Voltage Drain Current	IDSS	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V			1	μΑ
Gate-to-Source Leakage Current	IGSS	V <sub>GS</sub> =±8V, V <sub>DS</sub> =0V			±10	μΑ
Cutoff Voltage	VGS(off)	VDS=10V, ID=1mA	0.5		1.3	V
Forward Transfer Admittance	yfs	V <sub>DS</sub> =10V, I <sub>D</sub> =3.5A	7.0	10		S
Static Drain-to-Source On-State Resistance	R <sub>DS</sub> (on)1	I <sub>D</sub> =4A, V <sub>G</sub> S=4.5V		17	23	mΩ
	RDS(on)2	ID=4A, VGS=4.0V		18	24	mΩ
	R <sub>DS</sub> (on)3	I <sub>D</sub> =4A, V <sub>G</sub> S=3.1V		20	30	mΩ
	R <sub>DS</sub> (on)4	I <sub>D</sub> =2A, V <sub>G</sub> S=2.5V		24	35	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> =10V, f=1MHz		1140		pF
Output Capacitance	Coss	V <sub>DS</sub> =10V, f=1MHz		420		pF
Reverse Transfer Capacitance	Crss	V <sub>DS</sub> =10V, f=1MHz		190		pF

Marking: WB Continued on next page.

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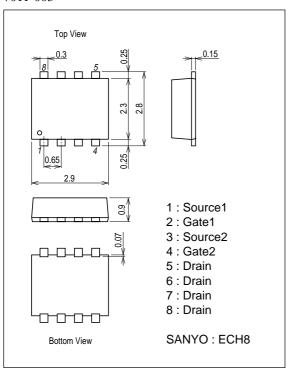
#### ECH8601R

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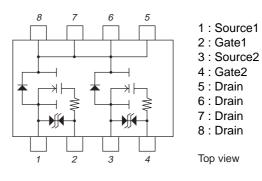
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Oill
Turn-ON Delay Time	t <sub>d</sub> (on)	See specified Test Circuit.		425		ns
Rise Time	t <sub>r</sub>	See specified Test Circuit.		1500		ns
Turn-OFF Delay Time	t <sub>d</sub> (off)	See specified Test Circuit.		4000		ns
Fall Time	tf	See specified Test Circuit.		2860		ns
Total Gate Charge	Qg	V <sub>DS</sub> =10V, V <sub>GS</sub> =10V, I <sub>D</sub> =6.5A		26.8		nC
Gate-to-Source Charge	Qgs	VDS=10V, VGS=10V, ID=6.5A		1.4		nC
Gate-to-Drain "Miller" Charge	Qgd	V <sub>DS</sub> =10V, V <sub>GS</sub> =10V, I <sub>D</sub> =6.5A		5.1		nC
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =6.5A, V <sub>G</sub> S=0V		0.75	1.2	V

#### **Package Dimensions**

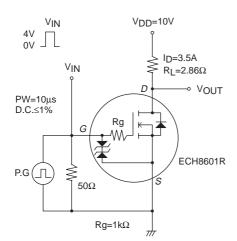
unit : mm 7011-003



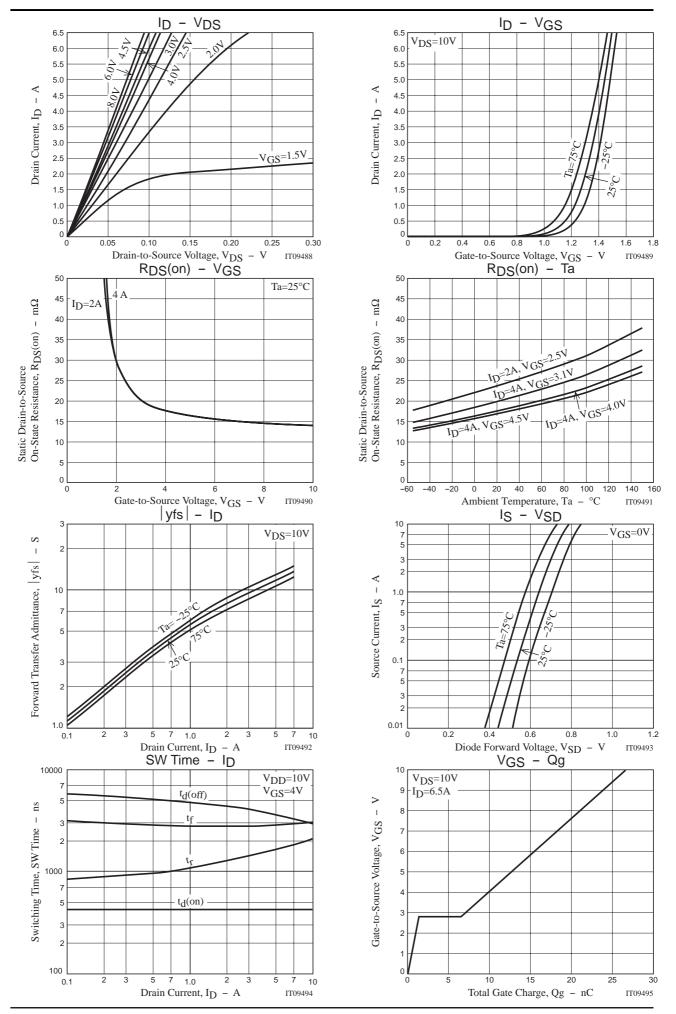
#### **Electrical Connection**



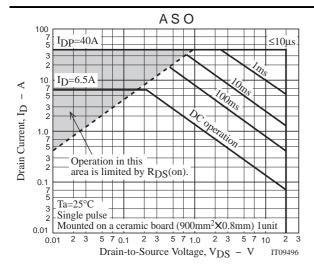
### **Switching Time Test Circuit**

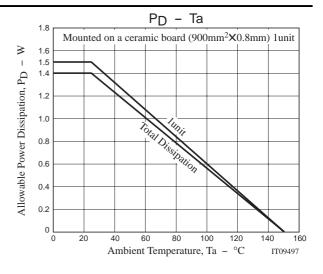


#### **ECH8601R**



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Note on usage : Since the ECH8601R is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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